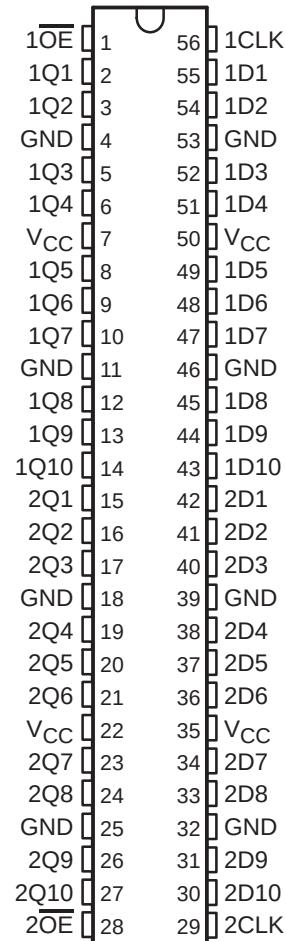


# SN54ABT16821, SN74ABT16821 20-BIT BUS-INTERFACE FLIP-FLOPS WITH 3-STATE OUTPUTS

SCBS216B – JUNE 1992 – REVISED JANUARY 1997

- Members of the Texas Instruments **Widebus™** Family
- State-of-the-Art **EPIC-II<sup>B</sup>**™ BiCMOS Design Significantly Reduces Power Dissipation
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Typical  $V_{OLP}$  (Output Ground Bounce) < 1 V at  $V_{CC} = 5$  V,  $T_A = 25^\circ\text{C}$
- Distributed  $V_{CC}$  and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- High-Drive Outputs (–32-mA  $I_{OH}$ , 64-mA  $I_{OL}$ )
- Package Options Include Plastic Thin Shrink Small-Outline (DGG), 300-mil Shrink Small-Outline (DL) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings

SN54ABT16821 . . . WD PACKAGE  
SN74ABT16821 . . . DGG OR DL PACKAGE  
(TOP VIEW)



## description

These 20-bit flip-flops feature 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. They are particularly suitable for implementing wider buffer registers, I/O ports, bidirectional bus drivers with parity, and working registers.

The 'ABT16821 can be used as two 10-bit flip-flops or one 20-bit flip-flop. The 20 flip-flops are edge-triggered D-type flip-flops. On the positive transition of the clock (CLK) input, the device provides true data at the Q outputs.

A buffered output-enable ( $\overline{OE}$ ) input can be used to place the ten outputs in either a normal logic state (high or low logic level) or a high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without need for interface or pullup components.

$\overline{OE}$  does not affect the internal operation of the flip-flops. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ABT16821 is characterized for operation over the full military temperature range of  $-55^\circ\text{C}$  to  $125^\circ\text{C}$ . The SN74ABT16821 is characterized for operation from  $-40^\circ\text{C}$  to  $85^\circ\text{C}$ .



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**TEXAS  
INSTRUMENTS**

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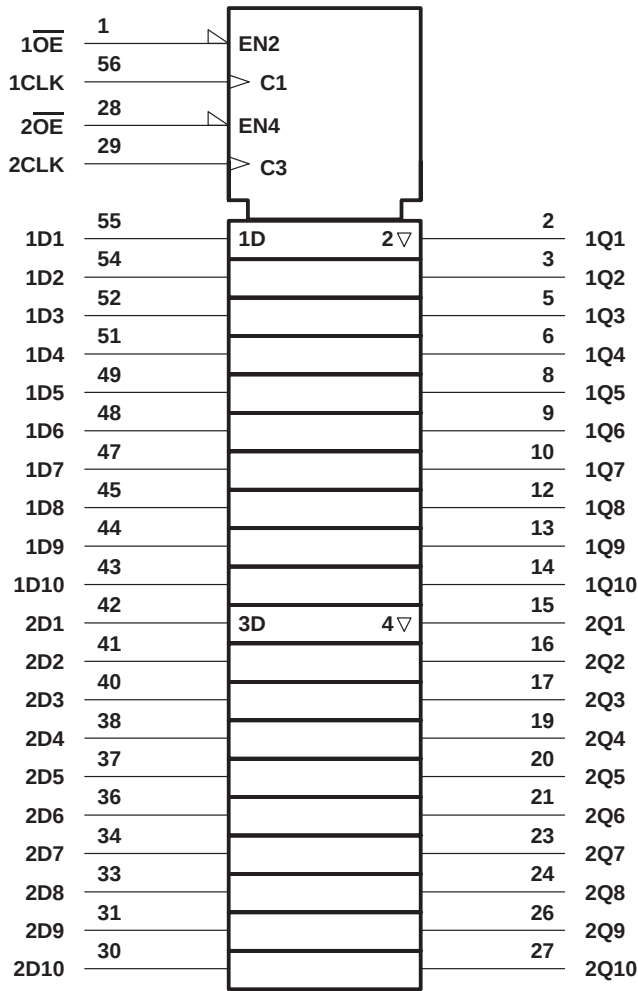
SN54ABT16821, SN74ABT16821  
20-BIT BUS-INTERFACE FLIP-FLOPS  
WITH 3-STATE OUTPUTS

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FUNCTION TABLE  
(each flip-flop)

| INPUTS          |            |   | OUTPUT<br>Q |
|-----------------|------------|---|-------------|
| $\overline{OE}$ | CLK        | D |             |
| L               | $\uparrow$ | H | H           |
| L               | $\uparrow$ | L | L           |
| L               | L          | X | $Q_0$       |
| H               | X          | X | Z           |

logic symbol†

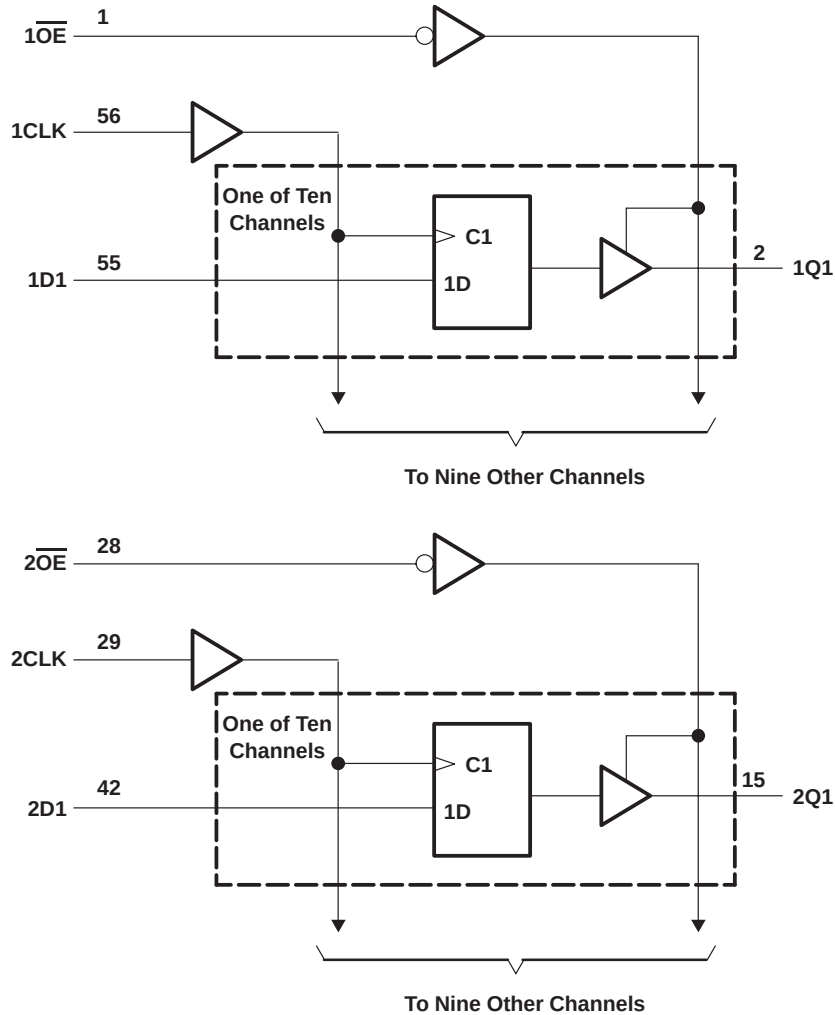


† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

# SN54ABT16821, SN74ABT16821 20-BIT BUS-INTERFACE FLIP-FLOPS WITH 3-STATE OUTPUTS

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## logic diagram (positive logic)



## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

|                                                                           |                 |
|---------------------------------------------------------------------------|-----------------|
| Supply voltage range, $V_{CC}$                                            | –0.5 V to 7 V   |
| Input voltage range, $V_I$ (see Note 1)                                   | –0.5 V to 7 V   |
| Voltage range applied to any output in the high or power-off state, $V_O$ | –0.5 V to 5.5 V |
| Current into any output in the low state, $I_O$ : SN54ABT16821            | 96 mA           |
| SN74ABT16821                                                              | 128 mA          |
| Input clamp current, $I_{IK}$ ( $V_I < 0$ )                               | –18 mA          |
| Output clamp current, $I_{OK}$ ( $V_O < 0$ )                              | –50 mA          |
| Package thermal impedance, $\theta_{JA}$ (see Note 2): DGG package        | 81°C/W          |
| DL package                                                                | 74°C/W          |
| Storage temperature range, $T_{stg}$                                      | –65°C to 150°C  |

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

2. The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51.



# SN54ABT16821, SN74ABT16821

## 20-BIT BUS-INTERFACE FLIP-FLOPS

### WITH 3-STATE OUTPUTS

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#### recommended operating conditions (see Note 3)

|                     |                                    | SN54ABT16821    |          | SN74ABT16821 |          | UNIT |
|---------------------|------------------------------------|-----------------|----------|--------------|----------|------|
|                     |                                    | MIN             | MAX      | MIN          | MAX      |      |
| $V_{CC}$            | Supply voltage                     | 4.5             | 5.5      | 4.5          | 5.5      | V    |
| $V_{IH}$            | High-level input voltage           | 2               |          | 2            |          | V    |
| $V_{IL}$            | Low-level input voltage            |                 | 0.8      |              | 0.8      | V    |
| $V_I$               | Input voltage                      | 0               | $V_{CC}$ | 0            | $V_{CC}$ | V    |
| $I_{OH}$            | High-level output current          |                 | –24      |              | –32      | mA   |
| $I_{OL}$            | Low-level output current           |                 | 48       |              | 64       | mA   |
| $\Delta t/\Delta v$ | Input transition rise or fall rate | Outputs enabled |          | 10           | 10       | ns/V |
| $T_A$               | Operating free-air temperature     | –55             | 125      | –40          | 85       | °C   |

NOTE 3: Unused inputs must be held high or low to prevent them from floating.

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER          | TEST CONDITIONS                                                                  | $T_A = 25^\circ\text{C}$ |                  |           | SN54ABT16821 |         | SN74ABT16821 |           | UNIT          |
|--------------------|----------------------------------------------------------------------------------|--------------------------|------------------|-----------|--------------|---------|--------------|-----------|---------------|
|                    |                                                                                  | MIN                      | TYP <sup>†</sup> | MAX       | MIN          | MAX     | MIN          | MAX       |               |
| $V_{IK}$           | $V_{CC} = 4.5\text{ V}$ , $I_I = -18\text{ mA}$                                  |                          |                  | –1.2      |              | –1.2    |              | –1.2      | V             |
| $V_{OH}$           | $V_{CC} = 4.5\text{ V}$ , $I_{OH} = -3\text{ mA}$                                | 2.5                      |                  |           | 2.5          |         | 2.5          |           | V             |
|                    | $V_{CC} = 5\text{ V}$ , $I_{OH} = -3\text{ mA}$                                  | 3                        |                  |           | 3            |         | 3            |           |               |
|                    | $V_{CC} = 4.5\text{ V}$                                                          | $I_{OH} = -24\text{ mA}$ | 2                |           | 2            |         |              |           |               |
|                    |                                                                                  | $I_{OH} = -32\text{ mA}$ | 2*               |           |              |         | 2            |           |               |
| $V_{OL}$           | $V_{CC} = 4.5\text{ V}$                                                          | $I_{OL} = 48\text{ mA}$  |                  | 0.55      |              | 0.55    |              |           | V             |
|                    |                                                                                  | $I_{OL} = 64\text{ mA}$  |                  | 0.55*     |              |         |              | 0.55      |               |
| $V_{hys}$          |                                                                                  |                          | 100              |           |              |         |              |           | mV            |
| $I_I$              | $V_{CC} = 5.5\text{ V}$ , $V_I = V_{CC}$ or GND                                  |                          |                  | $\pm 1$   |              | $\pm 1$ |              | $\pm 1$   | $\mu\text{A}$ |
| $I_{OZH}$          | $V_{CC} = 5.5\text{ V}$ , $V_O = 2.7\text{ V}$                                   |                          |                  | 50        |              | 50      |              | 50        | $\mu\text{A}$ |
| $I_{OZL}$          | $V_{CC} = 5.5\text{ V}$ , $V_O = 0.5\text{ V}$                                   |                          |                  | –50       |              | –50     |              | –50       | $\mu\text{A}$ |
| $I_{off}$          | $V_{CC} = 0$ , $V_I$ or $V_O \leq 4.5\text{ V}$                                  |                          |                  | $\pm 100$ |              |         |              | $\pm 100$ | $\mu\text{A}$ |
| $I_{CEX}$          | $V_{CC} = 5.5\text{ V}$ , $V_O = 5.5\text{ V}$   Outputs high                    |                          |                  | 50        |              | 50      |              | 50        | $\mu\text{A}$ |
| $I_O^\ddagger$     | $V_{CC} = 5.5\text{ V}$ , $V_O = 2.5\text{ V}$                                   | –50                      | –100             | –200      | –50          | –200    | –50          | –200      | mA            |
| $I_{CC}$           | $V_{CC} = 5.5\text{ V}$ , $I_O = 0$ ,<br>$V_I = V_{CC}$ or GND                   | Outputs high             |                  | 500       |              | 500     |              | 500       | $\mu\text{A}$ |
|                    |                                                                                  | Outputs low              |                  | 89        |              | 89      |              | 89        | mA            |
|                    |                                                                                  | Outputs disabled         |                  | 500       |              | 500     |              | 500       | $\mu\text{A}$ |
| $\Delta I_{CC}^\S$ | $V_{CC} = 5.5\text{ V}$ , One input at 3.4 V,<br>Other inputs at $V_{CC}$ or GND |                          |                  | 1.5       |              | 1.5     |              | 1.5       | mA            |
| $C_i$              | $V_I = 2.5\text{ V}$ or $0.5\text{ V}$                                           |                          |                  | 3.5       |              |         |              |           | pF            |
| $C_O$              | $V_O = 2.5\text{ V}$ or $0.5\text{ V}$                                           |                          |                  | 7.5       |              |         |              |           | pF            |

\* On products compliant to MIL-PRF-38535, this parameter does not apply.

<sup>†</sup> All typical values are at  $V_{CC} = 5\text{ V}$ .

<sup>‡</sup> Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

<sup>§</sup> This is the increase in supply current for each input that is at the specified TTL voltage level rather than  $V_{CC}$  or GND.

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**SN54ABT16821, SN74ABT16821**  
**20-BIT BUS-INTERFACE FLIP-FLOPS**  
**WITH 3-STATE OUTPUTS**

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**timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)**

|                    |                                        | $V_{CC} = 5\text{ V}$ ,<br>$T_A = 25^\circ\text{C}$ |     | SN54ABT16821 |     | SN74ABT16821 |     | UNIT |
|--------------------|----------------------------------------|-----------------------------------------------------|-----|--------------|-----|--------------|-----|------|
|                    |                                        | MIN                                                 | MAX | MIN          | MAX | MIN          | MAX |      |
| $f_{\text{clock}}$ | Clock frequency                        | 0                                                   | 150 | 0            | 150 | 0            | 150 | MHz  |
| $t_W$              | Pulse duration, CLK high or low        | 3.3                                                 |     | 3.3          |     | 3.3          |     | ns   |
| $t_{\text{su}}$    | Setup time, data before CLK $\uparrow$ | 1.8                                                 |     | 1.8          |     | 1.8          |     | ns   |
| $t_h$              | Hold time, data after CLK $\uparrow$   | 1.3                                                 |     | 1.3          |     | 1.3          |     | ns   |

**switching characteristics over recommended ranges of supply voltage and operating free-air temperature,  $C_L = 50\text{ pF}$  (unless otherwise noted) (see Figure 1)**

| PARAMETER        | FROM<br>(INPUT)        | TO<br>(OUTPUT) | $V_{CC} = 5\text{ V}$ ,<br>$T_A = 25^\circ\text{C}$ |     |     | SN54ABT16821 |     | SN74ABT16821 |     | UNIT |
|------------------|------------------------|----------------|-----------------------------------------------------|-----|-----|--------------|-----|--------------|-----|------|
|                  |                        |                | MIN                                                 | TYP | MAX | MIN          | MAX | MIN          | MAX |      |
| $f_{\text{max}}$ |                        |                | 150                                                 |     |     | 150          |     | 150          |     | MHz  |
| $t_{\text{PLH}}$ | CLK                    | Q              | 1.3                                                 | 3.7 | 5.1 | 1.3          | 6.7 | 1.3          | 6.1 | ns   |
| $t_{\text{PHL}}$ |                        |                | 1.6                                                 | 3.9 | 5.1 | 1.6          | 5.8 | 1.6          | 5.4 |      |
| $t_{\text{PZH}}$ | $\overline{\text{OE}}$ | Q              | 1.1                                                 | 3.2 | 4.7 | 1.1          | 5.8 | 1.1          | 5.7 | ns   |
| $t_{\text{PZL}}$ |                        |                | 1.6                                                 | 3.8 | 5   | 1.6          | 5.7 | 1.6          | 5.6 |      |
| $t_{\text{PHZ}}$ | $\overline{\text{OE}}$ | Q              | 2                                                   | 4.5 | 5.7 | 2            | 6.6 | 2            | 6.5 | ns   |
| $t_{\text{PLZ}}$ |                        |                | 1.8                                                 | 4.1 | 5.8 | 1.8          | 8.4 | 1.8          | 7.1 |      |

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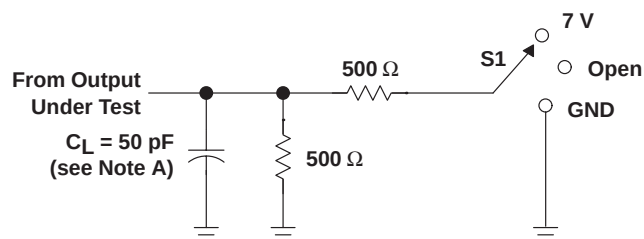
# SN54ABT16821, SN74ABT16821

## 20-BIT BUS-INTERFACE FLIP-FLOPS

### WITH 3-STATE OUTPUTS

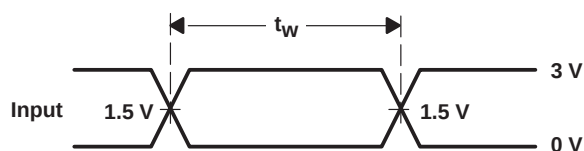
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#### PARAMETER MEASUREMENT INFORMATION

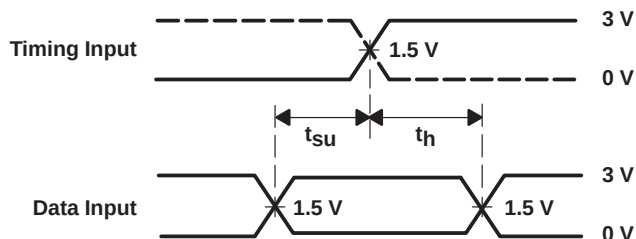


LOAD CIRCUIT

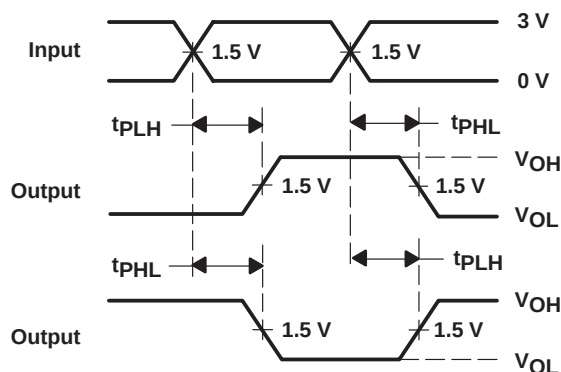
| TEST              | S1   |
|-------------------|------|
| $t_{PLH}/t_{PHL}$ | Open |
| $t_{PLZ}/t_{PZL}$ | 7 V  |
| $t_{PHZ}/t_{PZH}$ | Open |



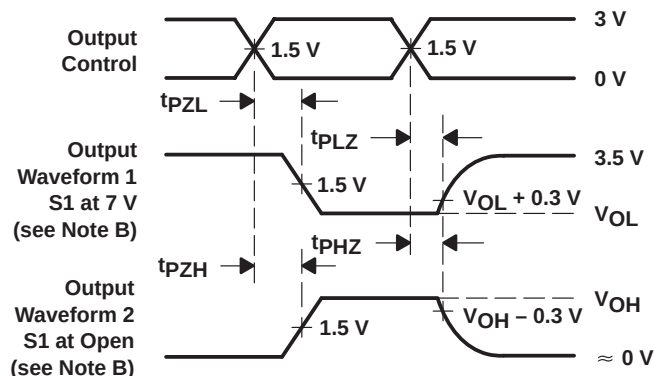
VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

- NOTES:
- $C_L$  includes probe and jig capacitance.
  - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5 \text{ ns}$ ,  $t_f \leq 2.5 \text{ ns}$ .
  - The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

## PACKAGING INFORMATION

| Orderable Device  | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|-------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| 74ABT16821DGGRE4  | ACTIVE                | TSSOP        | DGG             | 56   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74ABT16821DGGRG4  | ACTIVE                | TSSOP        | DGG             | 56   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74ABT16821DGGR  | ACTIVE                | TSSOP        | DGG             | 56   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74ABT16821DL    | ACTIVE                | SSOP         | DL              | 56   | 20          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74ABT16821DLG4  | ACTIVE                | SSOP         | DL              | 56   | 20          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74ABT16821DLR   | ACTIVE                | SSOP         | DL              | 56   | 1000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74ABT16821DLRG4 | ACTIVE                | SSOP         | DL              | 56   | 1000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

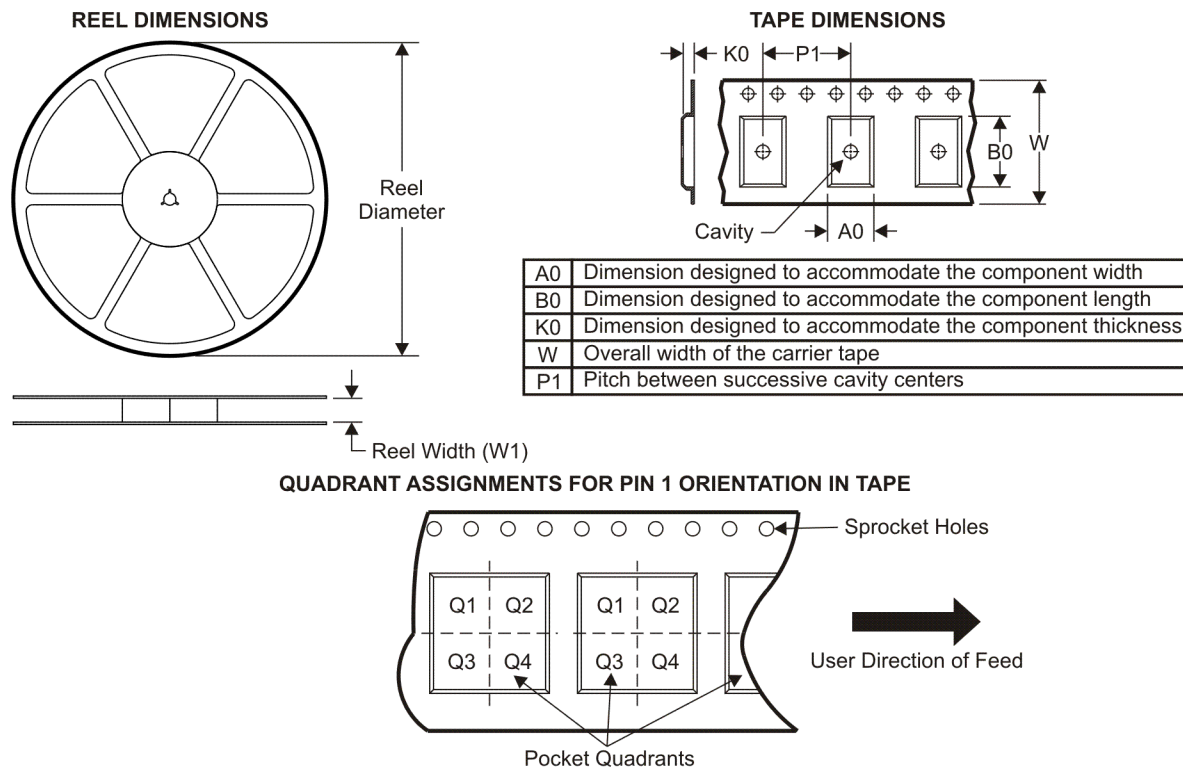
**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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**TAPE AND REEL INFORMATION**

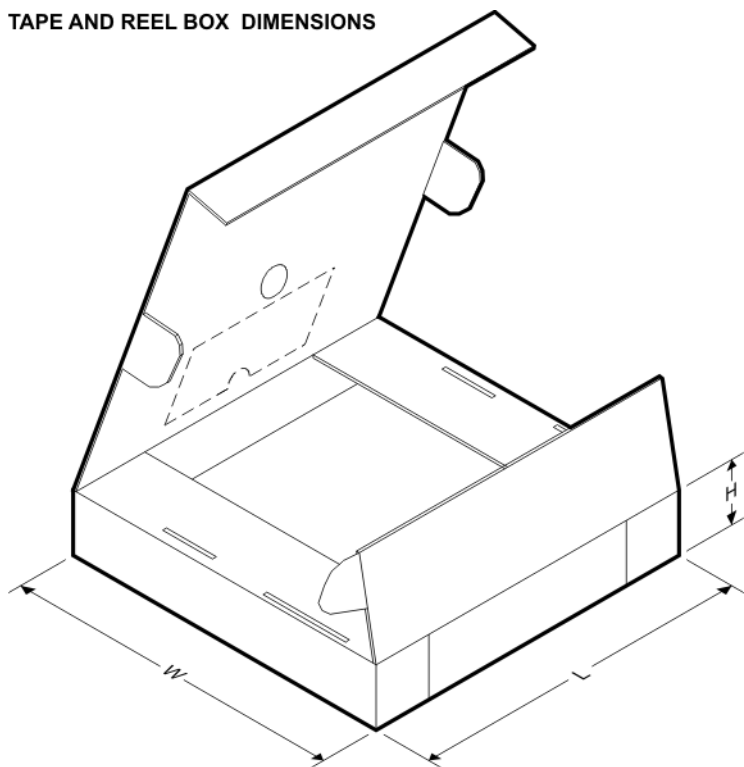


\*All dimensions are nominal

| Device           | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74ABT16821DGGR | TSSOP        | DGG             | 56   | 2000 | 330.0              | 24.4               | 8.6     | 15.6    | 1.8     | 12.0    | 24.0   | Q1            |
| SN74ABT16821DLR  | SSOP         | DL              | 56   | 1000 | 330.0              | 32.4               | 11.35   | 18.67   | 3.1     | 16.0    | 32.0   | Q1            |



## TAPE AND REEL BOX DIMENSIONS



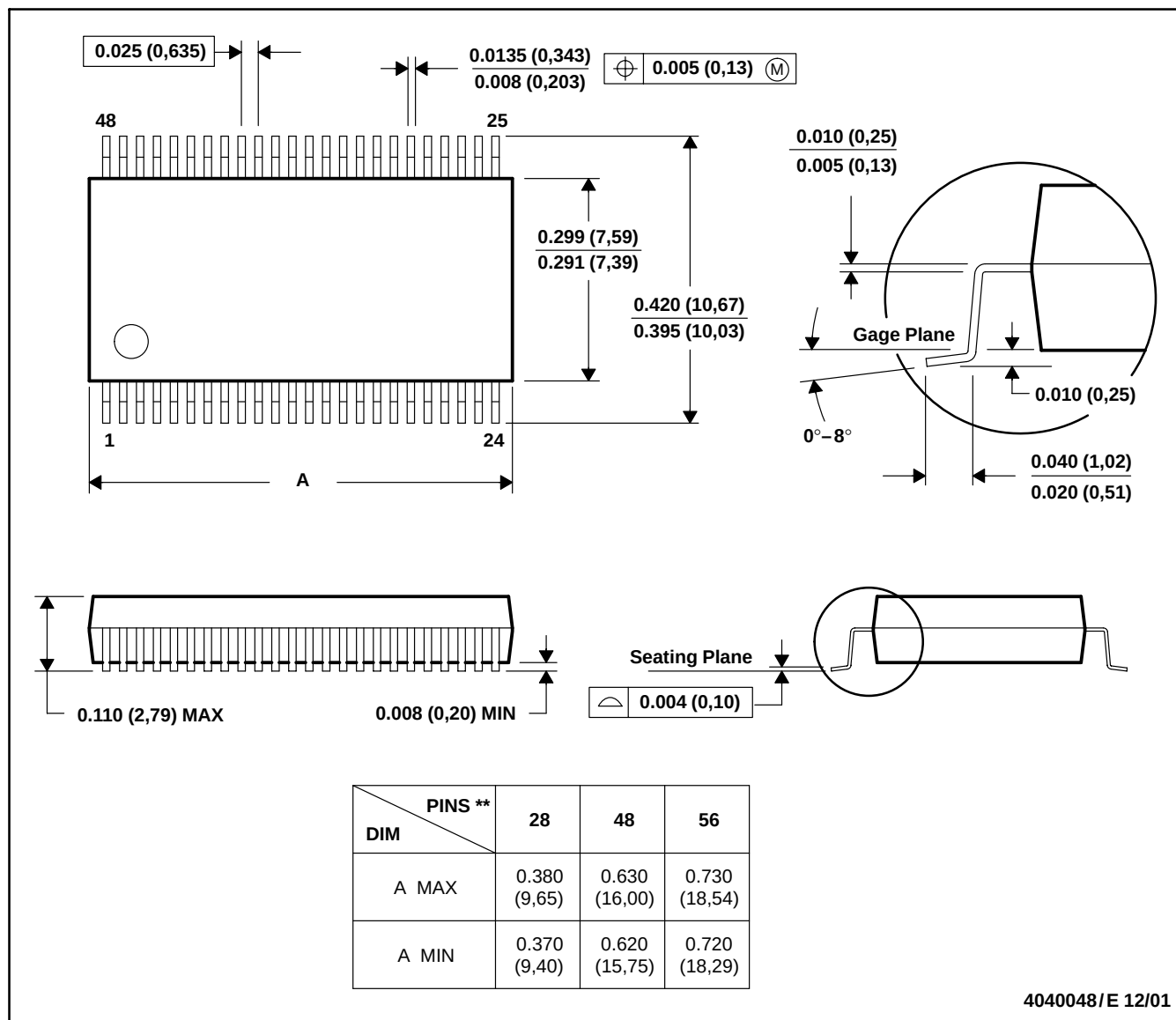
\*All dimensions are nominal

| Device           | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74ABT16821DGGR | TSSOP        | DGG             | 56   | 2000 | 346.0       | 346.0      | 41.0        |
| SN74ABT16821DLR  | SSOP         | DL              | 56   | 1000 | 346.0       | 346.0      | 49.0        |

DL (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN

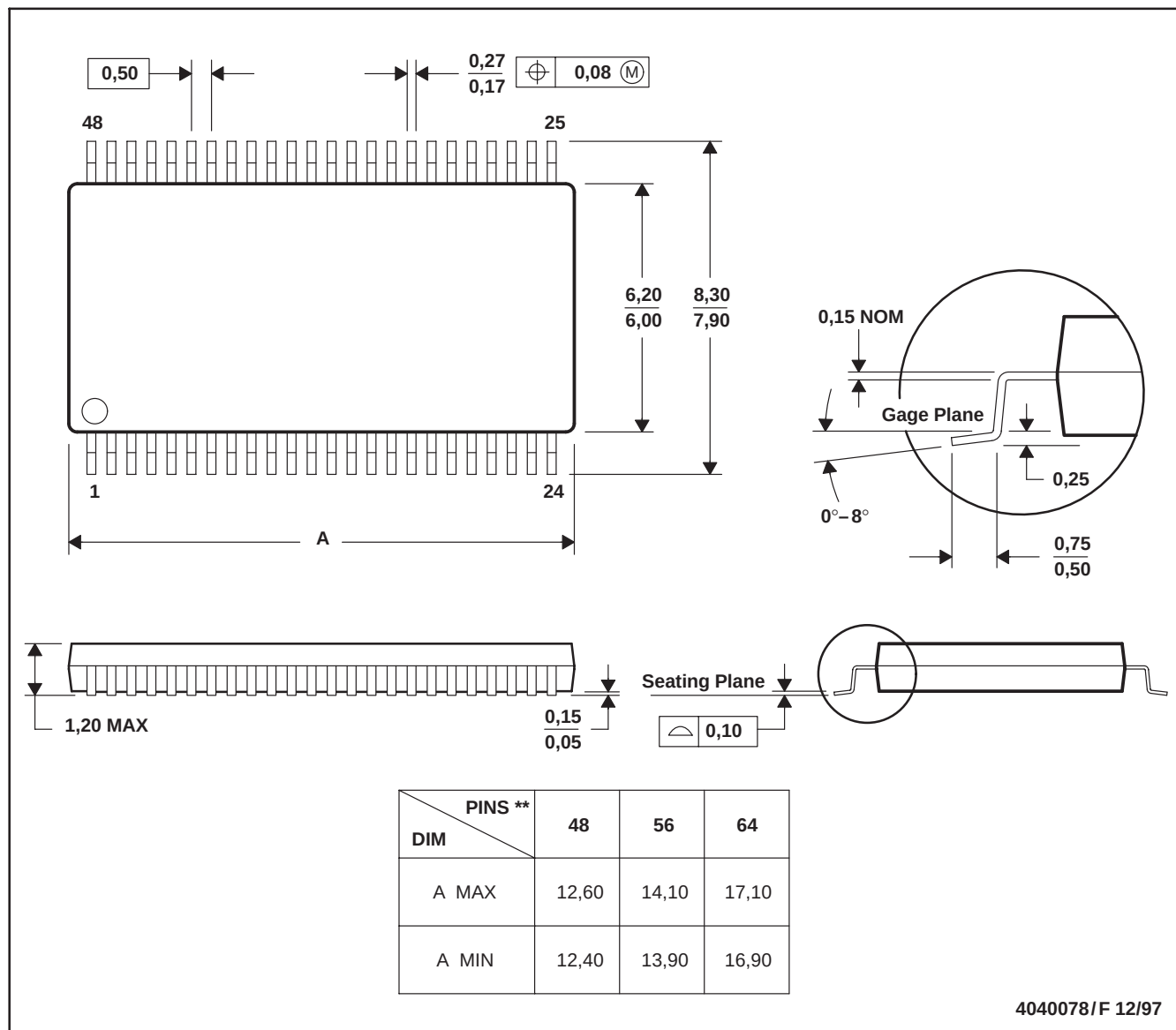


- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).  
 D. Falls within JEDEC MO-118

## DGG (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

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